



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

1.MATERIAL:

HOUSING: PBT, BLACK, UL94V-0
CONTACTS: 0.35[0.014] THICK PHOSPHOR BRONZE PLATED WITH
100μ" MINIMUM THICK TIN IN SOLDER AREA.
15μ" MINIMUM GOLD IN LOCALIZED PLATE AREA.
ENTIRE CONTACTS PLATED WITH 30μ" MINIMUM THICK NICKEL.

2.JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.

3.PART NUMBER: HRJ800615-U1588-F1

		UNIT	SCALE	SHEET	TITLE:
		mm[inch]		1 of 1	
		DRAWN BY	APPROVED BY		RJ45, MODULAR JACK, 1X5, W/O LED, 8P, 8C, UNSHIELDED, THRU-HOLE
		董正一	董正一		
		2004.08.23	2004.08.23		
		GENERAL TOLERANCE			
B1	REVISE	2005.12.30	X. X±0.25	ANGLE±	DRAW NO. : HRJ800615-U1588-F1
B0	NEW RELEASE	2005.12.22	X. XX±0.15		
REV.	DESCRIPTION	DATE	X. XXX±0.05		